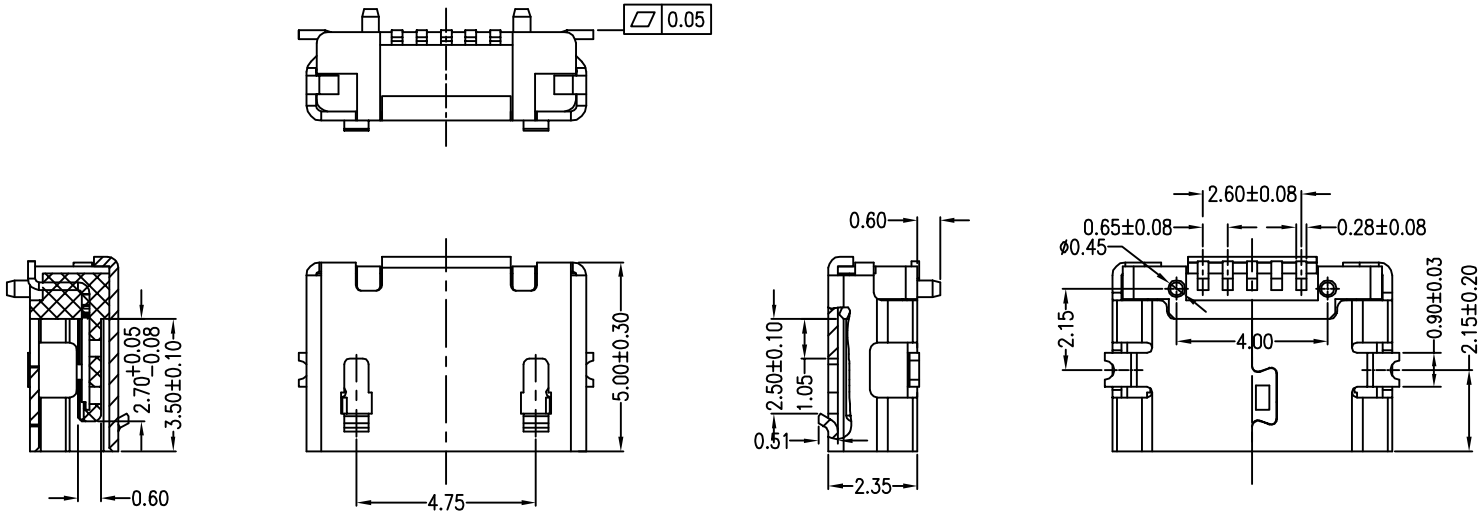
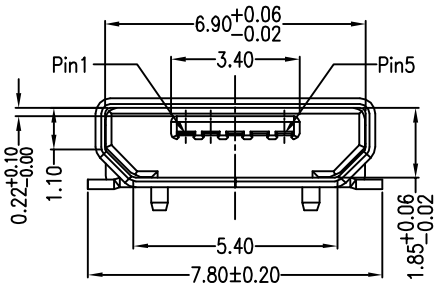
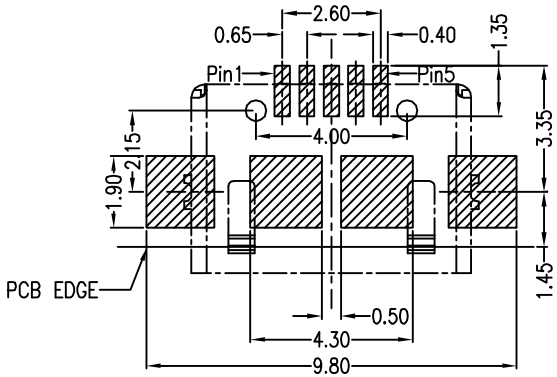
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE







RECOMMANDED PCB LAYOUT

Note:
1.Material:
1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
1.2 Contact: copper alloy,t=0.20mm
1.3 Shell: copper alloy,t=0.25mm
2.Specification:
2.1 Current rating: 1 A Max.
2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
2.3 Contact resistance: 50 mW Max.
2.4 Insulation resistance: 100 MW Min.
2.5 Total mating force: 3.57 Kgf Max.
2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.
2.7 Temperature range: -30°C~80°C

A 01 S B 1 4 1 B 2-274
① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩

① 产品代号 A:成品
② 产品系列 01:micro usb 5pin
③ 产品类别 S:母座
④ 产品类型 B:B TYPE
⑤ 外壳材质 1:C2680R-H
⑥ 端子材质 4:C5191R-EH
⑦ 主体材质 1:LCP
⑧ 主体颜色 B:黑色
⑨ 下板类型 2:smt
⑩ 细节流水 274:Micro usb 5s B Type Smt有柱有后盖无翻边

PART NO: A01SB141B2-274		MATERAL: SEE NOTE	
MODEL NO: XX		FINSH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	TITLE: Micro usb 5s B Type Smt有柱有后盖无翻边
TOLERANCE UNSPECIFIED .x 0.25 .xx 0.20 .xxx 0.15 Ang. 2°		DR: 夏友红	
		CHK:	DWG NO: A274 / REV: A
		APP:	SCALE: 5:1 / DATE: 2012.06.06